



## **Development of Tool Interoperability** Matrix based on Top Down SCL **Engineering Process: An ASEAN Case** Study Mohd Iqbal Ridwan TNBX Sdn. Bhd. iqbalri@tnb.com.my

**Presentation for IEC 61850 Global 2020 Conference** 





Tenaga Nasional Berhad (TNB) and IEC 61850

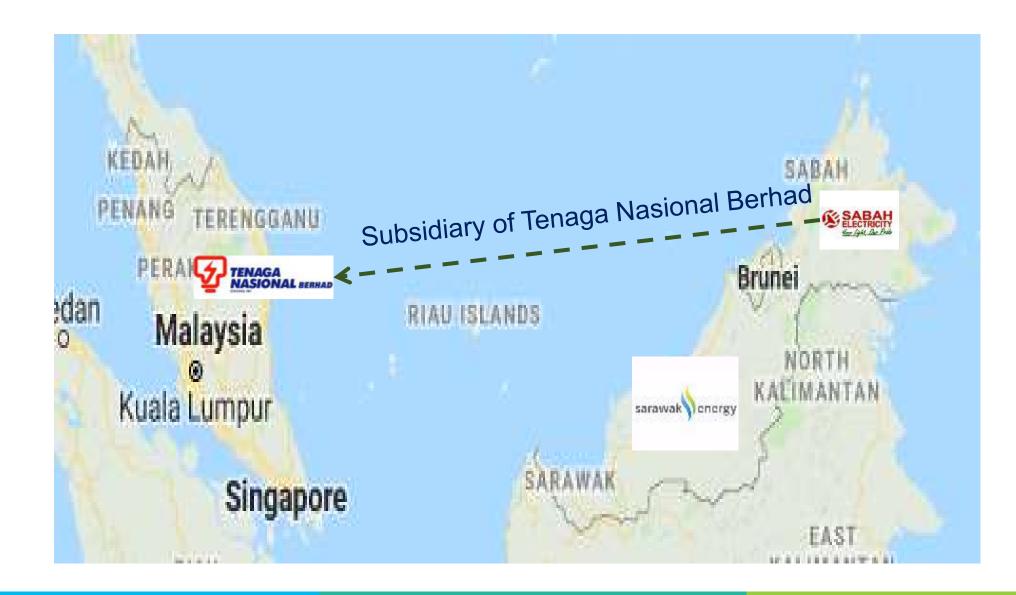
**Overview of IEC 61850 SCL and Engineering Process** 

Case Study: Top-down Engineering Process with ASEAN Utility





### Electric Utility Companies in Malaysia







### **Company and Speaker Background**

### **Company (Tenaga Nasional Berhad-TNB):**

- Vertically integrated utility company (Generation market liberalized)
- Generation, Transmission, Distribution, Retail divisions

### Speaker:

- Previously served as Principal Researcher in TNB Research Sdn. Bhd., wholly owned subsidiary of TNB.
- Led IEC 61850 related research, design, engineering, testing and training works
- Currently serving as Senior Manager in TNBX Sdn. Bhd., a subsidiary of Retail Division.
- Main responsibilities are business development and project management for behindthe-meter solutions











# TNB and IEC 61850





### TNB IEC 61850 Journey



2007

Commissioning of IEC 61850 System Verification and Simulation Laboratory First R&D Project (Station Bus) - feasibility studies and lab development

2010

#### 2012

1) Initiation of Product Acceptance Process

2) R&D Project on Process Bus

3) Pilot Multivendor Station Bus 132/33 kV **GIS Substation** project start

1) Process Bus Field **Trial Installation with** OCT - 1 bay

2015

2) Commissioning of **Pilot Multi-vendor** Station Bus 132/33 kV **GIS Substation** 

3) Initiated migration projects of legacy Substation Control Systems to IEC 61850

#### 2018 and beyond

1) Edition 2 Product Acceptance Process

2) Digital Substation R&D Project - inprogress

3) IEC 61850 Learning Journey for Grid Division 4) IEC 61850 Project

Implementation Process Enhancement

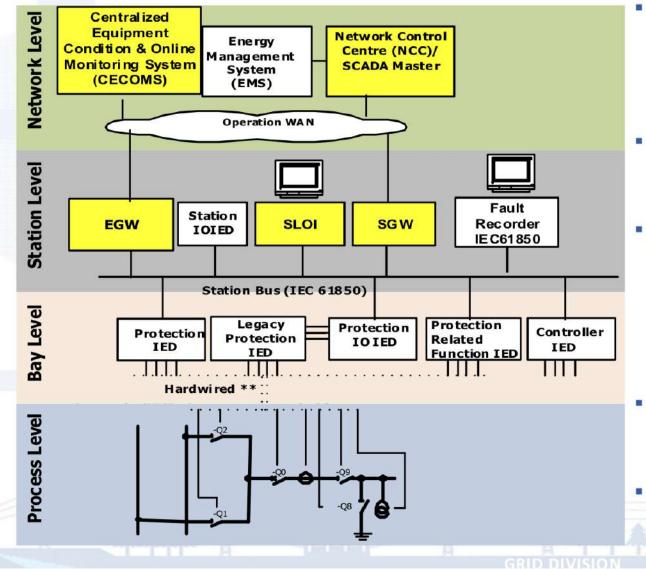


### IEC 61850 R&D Projects (2007 to 2019)



No.	Research Projects	Duration
1.	Research and Development on Substation Automation System based on IEC 61850 for Optimal Substation Design in TNB	2007 - 2010
2.	Study and Development of Integrated and Standardized Engineering Workstation (EWS) Applications for TNB Transmission IEC 61850 Based Substation Automation System	2010 -2012
3.	Modelling, Simulation & Performance Assessment of Power System Protection Functions in the IEC 61850 Based Substation Automation System in TNB	2010-2012
4.	Research on the Development of IEC 61850 Process Bus System and Guidelines for TRM Smart Substation Implementation in TNB Transmission	2012 – 2015
5.	Development of Substation Information Management Platform and Advanced IEC 61850 Substation Intelligent Management System (61850 SIMS) in Transmission Division	2013 -2015
6.	Research on Maintenance Strategies, Task and Implementations using Reliability Maintenance (RCM) and Standardized Testing Procedure for IEC 61850 based Substation Protection, Automation and Control Systems in TNB Transmission	2016 - 2017
7.	Development of IEC 61850 Specifications and Guidelines for the Implementation of Substation Protection, Automation and Control System (SPACS) in TNB Distribution	2016-2017
8.	Development of IEC 61850 Substation Protection, Automation and Control System Pilot Project for TNB Distribution Division	2017-2018
9.	Research and Development of IEC 61850 based Digital Substation 2.0 for TNB Grid Division	2019-present

## General Architecture for Legacy to IEC 61850 Migration Projects



- 1 Gbps optical fibre Ethernet LAN Station Bus backbone with distributed architecture
  - Ring network topology
  - Redundancy formed by ESM for each bay, clients and station
  - □ Time Synchronizing (SNTP)
- Clients MMS application:

  - SGW
  - □ EGW to support CECOMS
- IEDs (Servers):
  - Integrated Line Protection
  - New Circuit Breaker Management (CBM) CBF, ARSYN, OC, Pole Discordance
  - □ Bay Controller (per CB)
  - □ IOIED for Station alarm and Txmr bay
  - □ Low Impedance Busbar protection
- Tripping Scheme hardwire:
  - direct to Trip coil and Master trip
  - CBF tripping bus-wire
  - Live Protection Maintenance
- **Control GOOSE application** 
  - □ Interlock (Order Running, CB Trip Block under
    - Live Transfer etc)
  - Autoreclose & DFR initiation



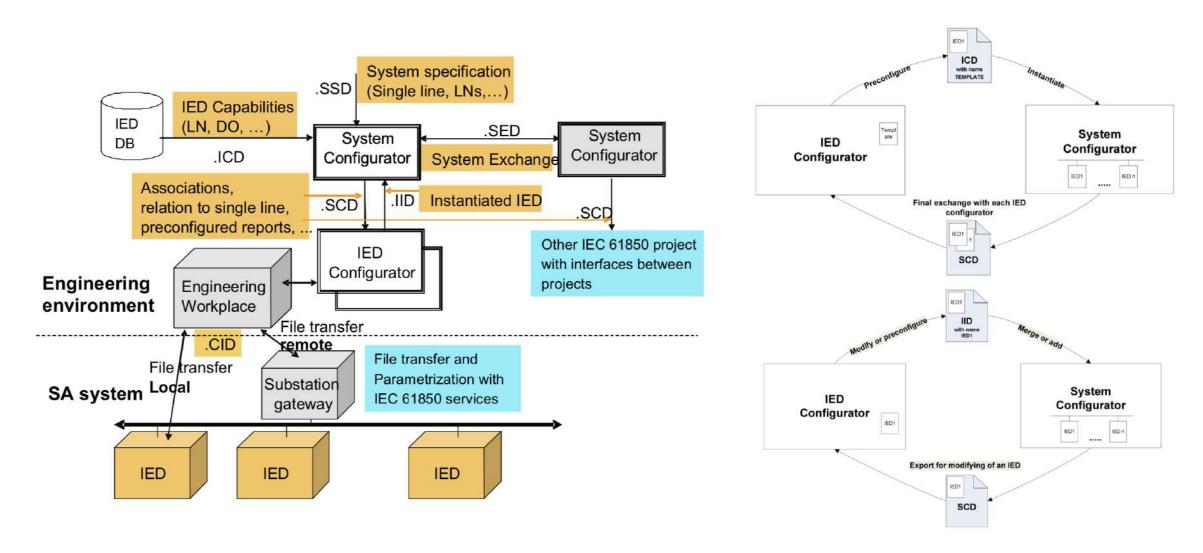


# Overview of IEC 61850 System Configuration description Language (SCL) and Engineering Process





### **Basic Engineering Flow**

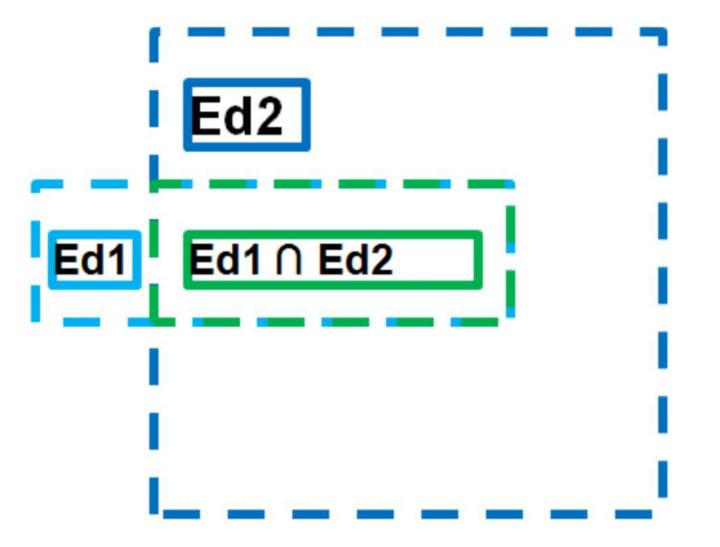


Source: IEC 61850-6:2009





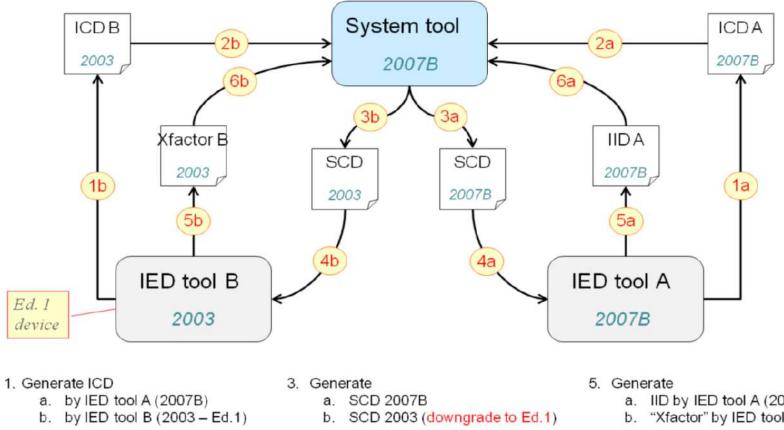
## Edition 1 and Edition 2 Area of Compatibility



#1: Edition 1 and Edition 2 Mixed Engineering Process – TNBX ENAGA VASIONAL Better Brighter.



Single System Configuration Tool (SCT) with Different SCL Versions



a. IED tool A imports SCD 2007B

b. IED tool B imports SCD 2003

4. SCD import

- 2. System tool imports
  - a. ICDA
  - b. ICD B (upgrade to SCL 2007B)

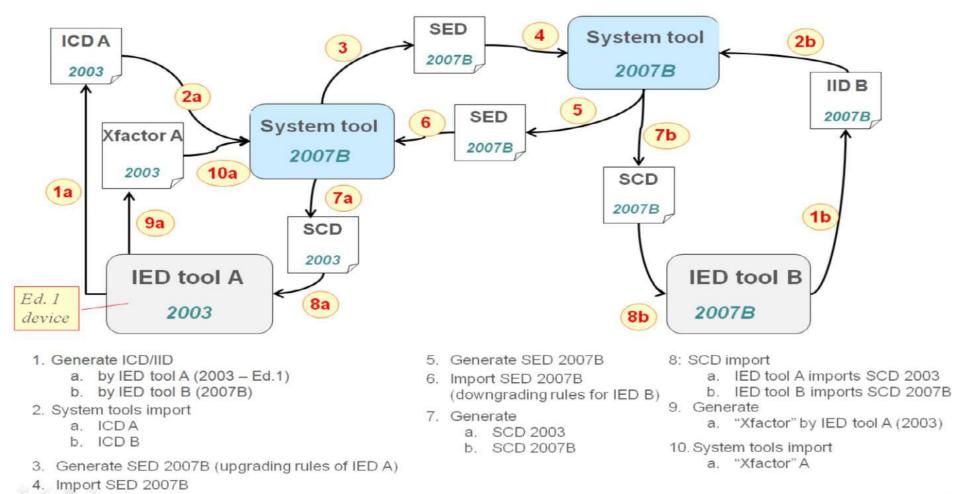
- a. IID by IED tool A (2007B)
- b. "Xfactor" by IED tool B (2003)
- 6. System tool imports
  - a. IIDA
  - b. "Xfactor" B (upgrade to 2007B)



### #2: Edition 1 and Edition 2 Mixed Engineering Process – TNBX Multiple System Configuration Tool (SCT) with Different **SCL Versions**

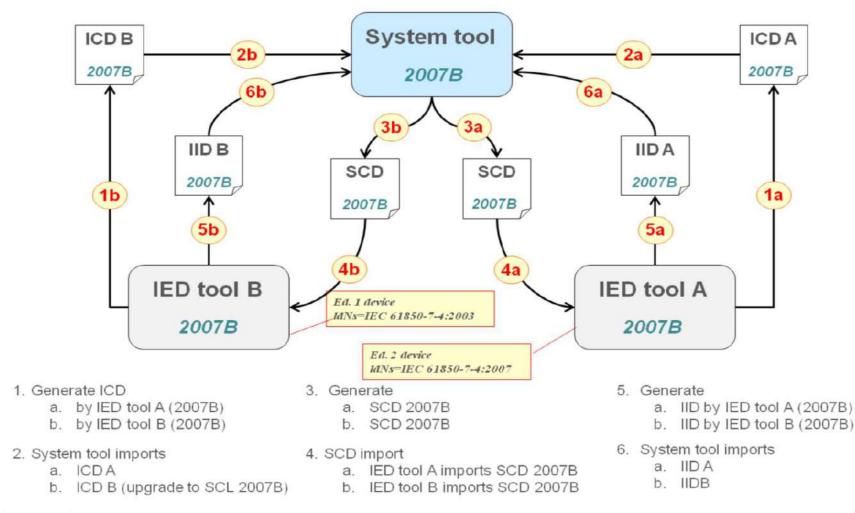








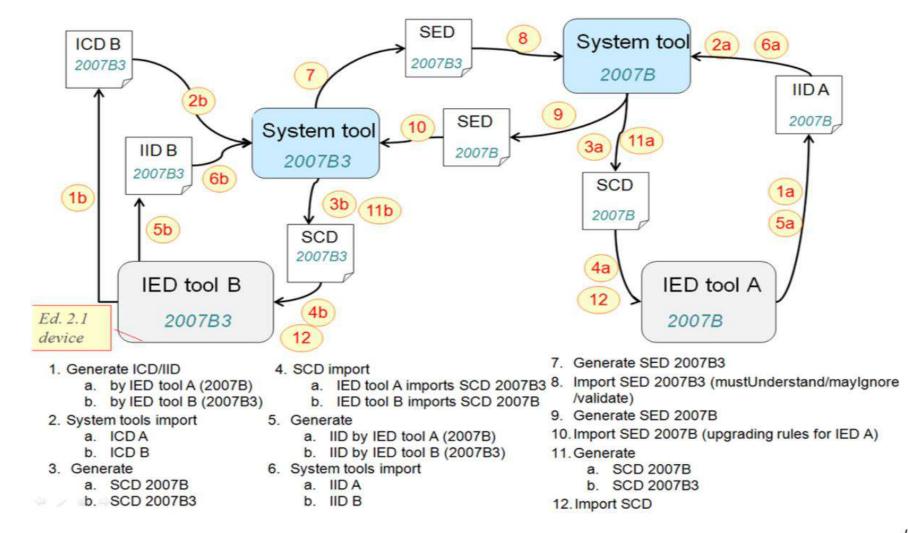




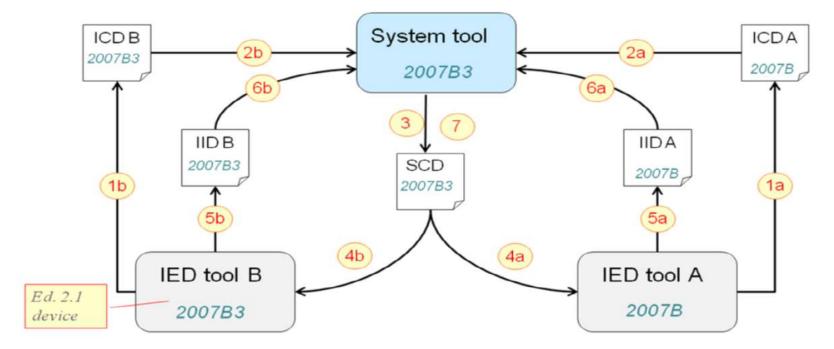


Source: IEC 61850-6:2009+AMD1:2018

# #4: Edition 2.1 and Edition 2 Mixed Engineering Process



### **FINE #5: Edition 2.1 and Edition 2 Mixed Engineering Process** Single Edition 2.1 SCT



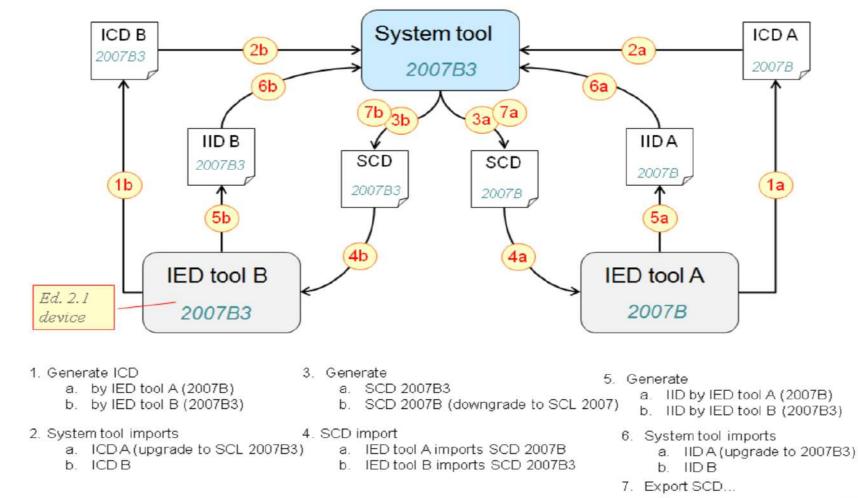
- 1. Generate ICD
  - a. by IED tool A (2007B)
  - b. by IED tool B (2007B3)
- 2. System tool imports
  - a. ICDA (upgrade to SCL 2007B3)
  - b. ICD B

- 3. Generate SCD 2007B3
- SCD import
  - a. IED tool A imports SCD 2007B3 (mustUnderstand/mayIgnore)
  - a. IED tool B imports SCD 2007B3
- a. IID by IED tool A (2007B)
  b. IID by IED tool B (2007B3)

Generate

- 6. System tool imports
  - a. IID A (upgrade to 2007B3)
  - b. IID B
- 7. Export SCD...









## Case Study: Top-down Engineering Process with ASEAN Utility



### Case Study Background

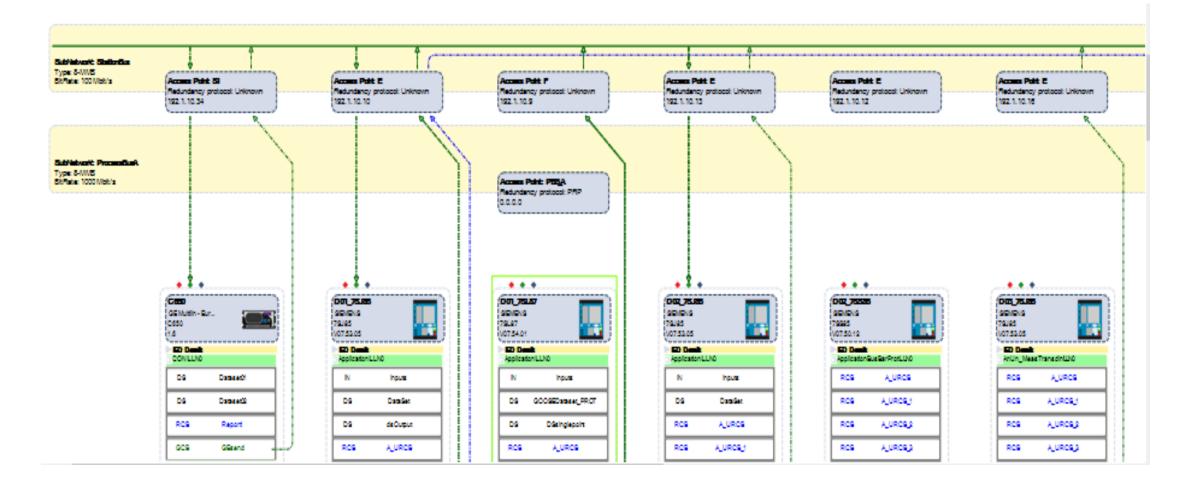


- Speaker was appointed as consultant by an ASEAN utility company in September 2019
- Project objective: To prove a working IEC 61850 top-down engineering process in multivendor laboratory environment
- IEDs involved:
  - SIEMENS (2 units Edition 2 IEDs)
  - Schneider Electric (1 unit Edition 2 IED)
  - ➢ GE Multilin (1 unit Edition 2 IED)
  - > ABB (1 unit Edition 2 IED)
  - Toshiba (1 unit Edition 1 IED)
- Success criterions:
  - Successful import of .scd file from SCT by IED Configuration Tool
  - Successful initiation of signals among IEDs
- Tools used:
  - SCT SCL Matrix from GridSoftware
  - Client Simulator IED Scout from Omicron Gmbh
  - IED Configuration Tools (ICT)





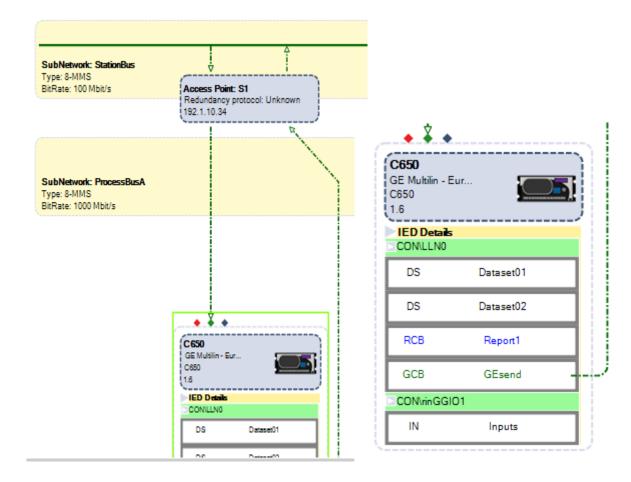
### Dataflow Diagram in SCL Matrix - General



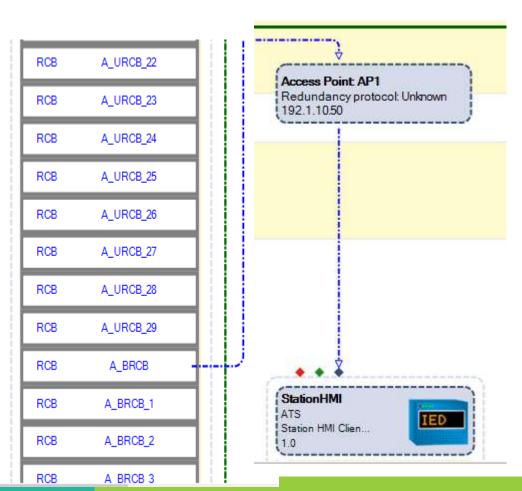


# Dataflow Diagram in SCL Matrix – GOOSE and Client-

#### **GOOSE** Publish and Subscribe



#### **Client-Server: IED to HMI**





### **GOOSE Subscription Input Configuration**



Home Engineering Process	Add Import/E:	vport										Select Logical Node	×
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• 👝 C650	👘 🖪 GO	OSE Sul	oscribers								1	LLN0	
D01_75J85												DRPRDR	
) 💼 D01_7SL87	AP	LD	LN GCB Name	DataSet	C650 (S1)	D01_7SJ85 (E)	D01_7SL87 (F)	D02_7SJ85 (E)	D02_7SS85 (E)	D03_7SJ85 (E)	P645_D03 (AP1	CMMXU1	
▶ <u></u> D02_75J85	→ C65	0									<b>_</b>	CVMMXN	·
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 Need to choose predefined GOOSE input in IEDs or utilize the 'No LN' feature for input binding in ICT after export of .scd file

# Edition 2 to Edition 1 Downgrade Process Implemented in The Project

- 1) Export .cid file (Ed. 2) from .scd file (Ed. 2) created in SCL Matrix
- 2) Launch OMICRON IED Scout. Import the .cid file (Ed. 2) to IED Scout.
- 3) Save the .cid file (Ed. 2) as Ed. 1 .cid (options SCL Schema version 1.4, 1.5 and 1.7)
- 4) Import the .cid file (Ed. 1) to Ed. 1 ICT



Publisher



### **Result: Tool Interoperability Matrix**

	_	Subscriber			Subscriber (Ed. 1
IED (IEC 61850 Ed. 2)	Vendor A	Vendor B	Vendor C	Vendor D	Vendor E
	Model 1 to				
	Model 2	Top down (.iid)	Top down (.iid)		
	Top down (.iid)	Input:	Input:	Top down (.iid)	Unsuccessful
Vendor A	Input: NO LN	System.GosGGIO1	CON.rinGGIO1	Input: LD0.LLN0	configuration
			<b>T</b> erraria (1994)		
			Top down (.iid)		
Vender D	Top down (.iid)		Input:	Top down (.iid)	SCL Ed. 2 to Ed. 1
Vendor B	Input: NO LN		CON.rinGGIO1	Input: LD0.LLN0	Downgrade
		Top down (.iid)			
	Top down (.iid)	Input:		Top down (.iid)	SCL Ed. 2 to Ed. 1
Vendor C	Input: NO LN	System.GosGGIO1		Input: LD0.LLN0	Downgrade
		Top down (.iid)	Top down (.iid)		
	Top down (.iid)	Input:	Input:		Unsuccessful
Vendor D	Input: NO LN	System.GosGGIO1	CON.rinGGIO1		configuration





### **Summary and Conclusion**

- Generally, the project has proven successful information exchange achieved from top-down engineering approach
- Edition 2 ICTs did not exhibit any major issues when importing .scd file generated from third-party SCT
- For Edition 2 to Edition 1 IED engineering, non-standard downgrade process was the only way for successful SCL file import in Edition 1 ICT. Methods suggested in IEC 61850-6:2009+AMD1:2018 did not properly work as Edition 1 ICT could not parse the downgraded .scd file from SCT
- The utilization of 'No LN' method in SCT was because certain ICT did not allow insertion of new external input in SCTs. Some IEDs have fixed LNs designated for GOOSE input signals
- Some issues observed in the project were similar to the findings in UCA IOP 2019 where mostly related to implementation issues in ICT and IED vendors
- The latest version of SCT fully supports ExtRef attributes as outlined in IEC 61850-6:2009+AMD1:2018. To be tested in TNB Research IEC 61850 laboratory and on-going Digital Substation research project

# HARK YOU

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Senri no michi mo, ippo kara hajimaru